FAIRCHILD SEMICONDUCTOR®

March 2013

# FDPF5N50UT

## N-Channel UniFET™ Ultra FRFET™ MOSFET

**500 V, 4 A, 2.0 Ω**

### Features

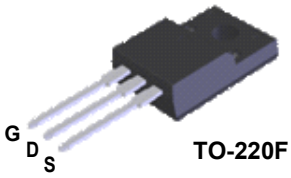
- $R_{DS(on)}$ = 1.65 Ω (Typ.) @ $V_{GS}$ = 10 V, $I_D$ = 2 A
- Low Gate Charge (Typ. 11 nC)
- Low $C_{rss}$ (Typ. 5 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

### Applications

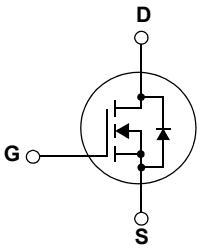
- LCD/LED TV
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

### Description

UniFET™ MOSFET is Fairchild Semiconductor®'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. UniFET Ultra FRFET™ MOSFET has much superior body diode reverse recovery performance. Its $t_{rr}$ is less than 50nsec and the reverse dv/dt immunity is 20V/nsec while normal planar MOSFETs have over 200nsec and 4.5V/nsec respectively. Therefore UniFET Ultra FRFET MOSFET can remove additional component and improve system reliability in certain applications that require performance improvement of the MOSFET's body diode. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.




TO-220F




## MOSFET Maximum Ratings $T_C$ = 25°C unless otherwise noted*

| Symbol | Parameter | | | FDPF5N50UT | Unit |
|---|---|---|---|---|---|
| $V_{DSS}$ | Drain to Source Voltage | | | 500 | V |
| $V_{GSS}$ | Gate to Source Voltage | | | ±30 | V |
| $I_D$ | Drain Current | - Continuous ($T_C$ = 25°C) | | 4* | A |
| | | - Continuous ($T_C$ = 100°C) | | 2.4* | |
| $I_{DM}$ | Drain Current | - Pulsed | (Note 1) | 16* | A |
| $E_{AS}$ | Single Pulsed Avalanche Energy | | (Note 2) | 216 | mJ |
| $I_{AR}$ | Avalanche Current | | (Note 1) | 4 | A |
| $E_{AR}$ | Repetitive Avalanche Energy | | (Note 1) | 8.5 | mJ |
| dv/dt | Peak Diode Recovery dv/dt | | (Note 3) | 20 | V/ns |
| $P_D$ | Power Dissipation | ($T_C$ = 25°C) | | 28 | W |
| | | - Derate above 25°C | | 0.22 | W/°C |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | | -55 to +150 | °C |
| $T_L$ | Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds | | | 300 | °C |

*Drain current limited by maximum junction temperature

## Thermal Characteristics

| Symbol | Parameter | FDPF5N50UT | Unit |
|---|---|---|---|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 4.5 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 62.5 | |

## Package Marking and Ordering Information $T_C = 25^oC$ unless otherwise noted

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|---|---|---|---|---|---|
| FDPF5N50UT | FDPF5N50UT | TO-220F | - | - | 50 |

## Electrical Characteristics

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
|---|---|---|---|---|---|---|
| **Off Characteristics** | | | | | | |
| $BV_{DSS}$ | Drain to Source Breakdown Voltage | $I_D = 250\mu A$, $V_{GS} = 0V$, $T_J = 25^oC$ | 500 | - | - | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250\mu A$, Referenced to $25^oC$ | - | 0.7 | - | $V/^oC$ |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS} = 500V$, $V_{GS} = 0V$ | - | - | 25 | $\mu A$ |
| | | $V_{DS} = 400V$, $T_C = 125^oC$ | - | - | 250 | |
| $I_{GSS}$ | Gate to Body Leakage Current | $V_{GS} = \pm 30V$, $V_{DS} = 0V$ | - | - | ±100 | nA |
| **On Characteristics** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 250\mu A$ | 3 | - | 5 | V |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS} = 10V$, $I_D = 2A$ | - | 1.65 | 2 | Ω |
| $g_{FS}$ | Forward Transconductance | $V_{DS} = 40V$, $I_D = 2A$ | - | 4.8 | - | S |
| **Dynamic Characteristics** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS} = 25V$, $V_{GS} = 0V$, f = 1MHz | - | 485 | 650 | pF |
| $C_{oss}$ | Output Capacitance | | - | 65 | 90 | pF |
| $C_{rss}$ | Reverse Transfer Capacitance | | - | 5 | 8 | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10V | $V_{DS} = 400V$, $I_D = 4A$, $V_{GS} = 10V$ (Note 4) | - | 11 | 15 | nC |
| $Q_{gs}$ | Gate to Source Gate Charge | | - | 3 | - | nC |
| $Q_{gd}$ | Gate to Drain “Miller” Charge | | - | 5 | - | nC |
| **Switching Characteristics** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD} = 250V$, $I_D = 4A$, $R_G = 25\Omega$ (Note 4) | - | 14 | 38 | ns |
| $t_r$ | Turn-On Rise Time | | - | 21 | 52 | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | - | 27 | 64 | ns |
| $t_f$ | Turn-Off Fall Time | | - | 20 | 50 | ns |
| **Drain-Source Diode Characteristics** | | | | | | |
| $I_S$ | Maximum Continuous Drain to Source Diode Forward Current | | - | - | 4 | A |
| $I_{SM}$ | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | 16 | A |
| $V_{SD}$ | Drain to Source Diode Forward Voltage | $V_{GS} = 0V$, $I_{SD} = 4A$ | - | - | 1.6 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{GS} = 0V$, $I_{SD} = 4A$, $dI_F/dt = 100A/\mu s$ | - | 36 | - | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | - | 33 | - | nC |

**Notes:**
1: Repetitive Rating: Pulse width limited by maximum junction temperature
2: L = 27mH, $I_{AS} = 4A$, $V_{DD} = 50V$, $R_G = 25\Omega$, Starting $T_J = 25°C$
3: $I_{SD} \le 4A$, $di/dt \le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25°C$
4: Essentially Independent of Operating Temperature Typical Characteristics

## Typical Performance Characteristics

**Figure 1. On-Region Characteristics**

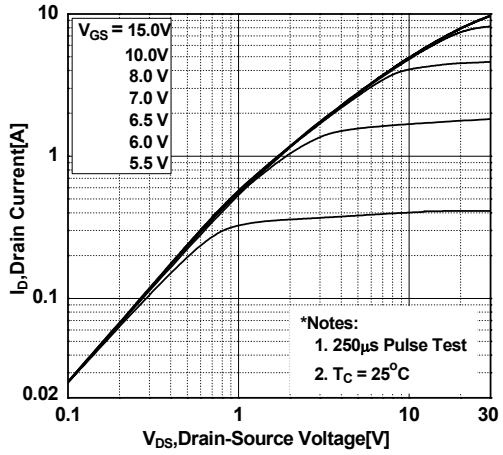



**Figure 2. Transfer Characteristics**

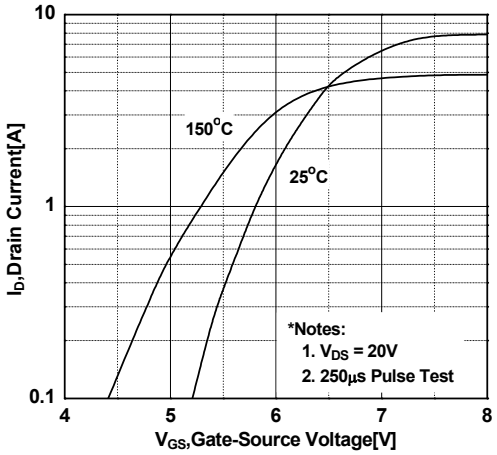



**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**

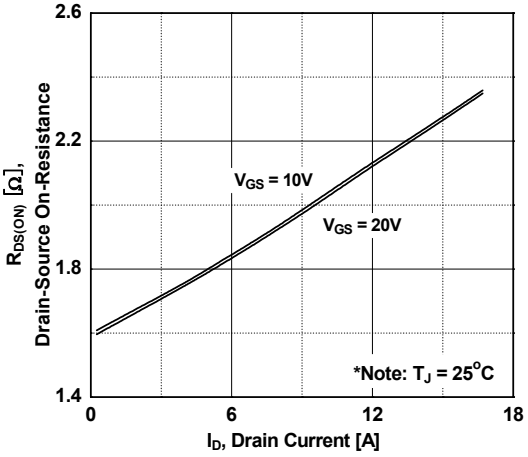



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

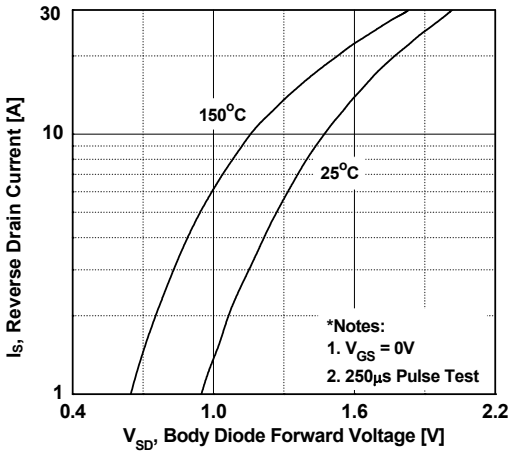



**Figure 5. Capacitance Characteristics**

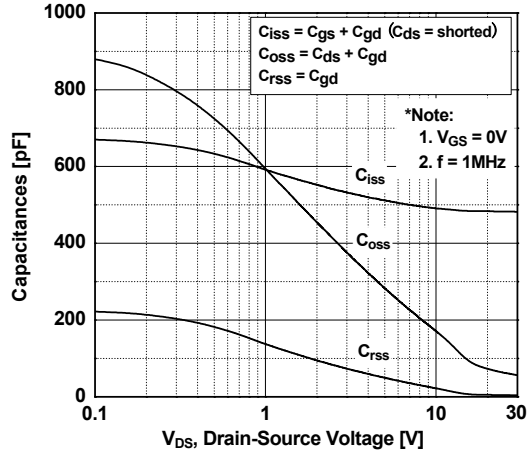
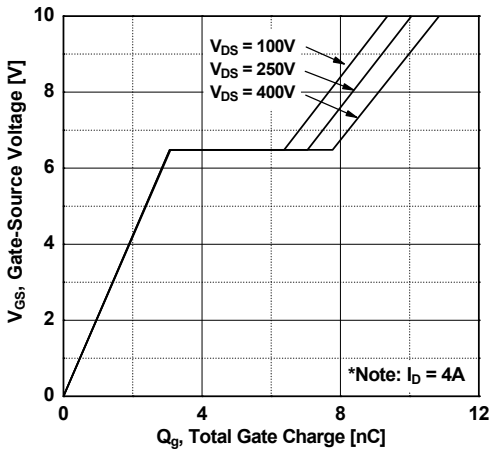



**Figure 6. Gate Charge Characteristics**



## Typical Performance Characteristics (Continued)

**Figure 7. Breakdown Voltage Variation vs. Temperature**

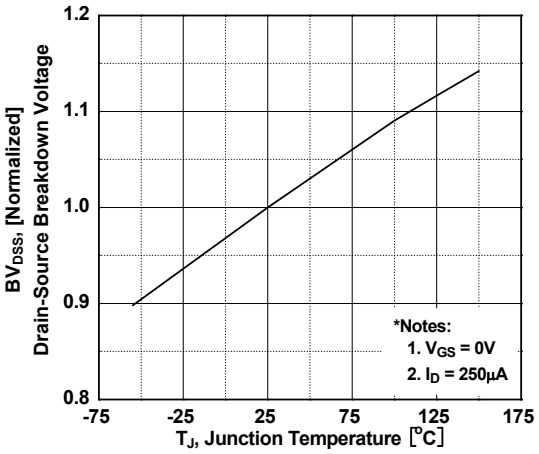



**Figure 8. Maximum Safe Operating Area**

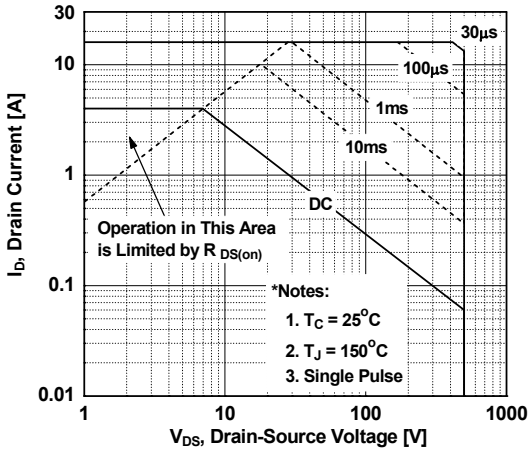



**Figure 9. Maximum Drain Current vs. Case Temperature**

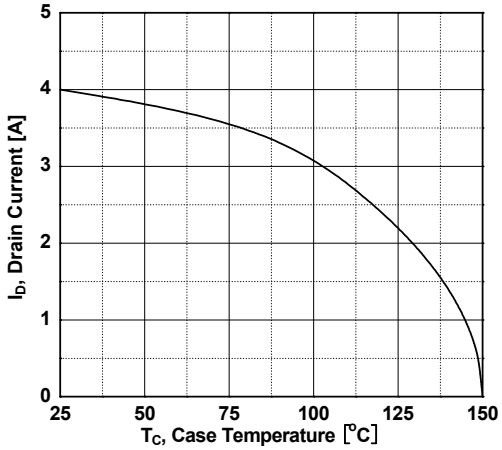
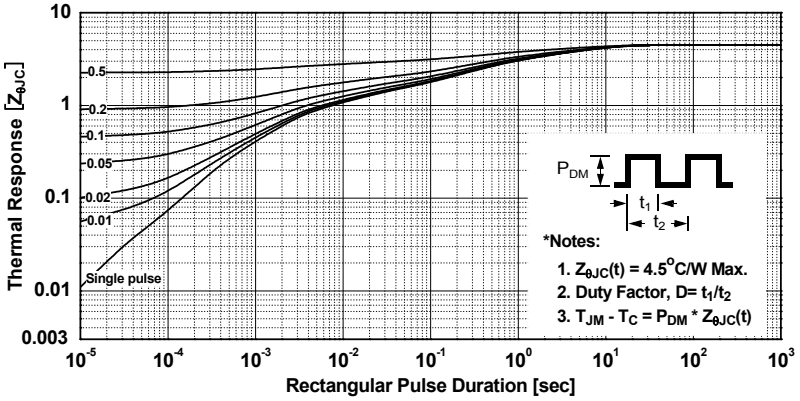
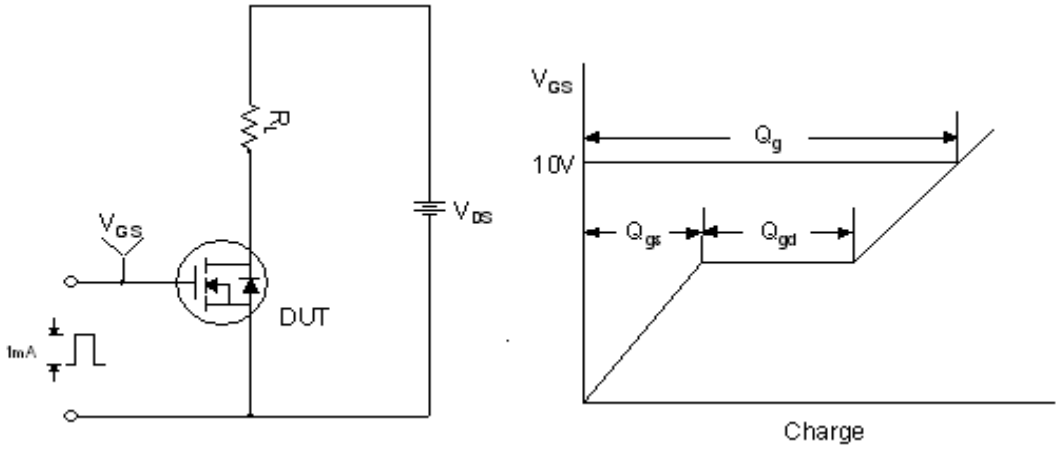


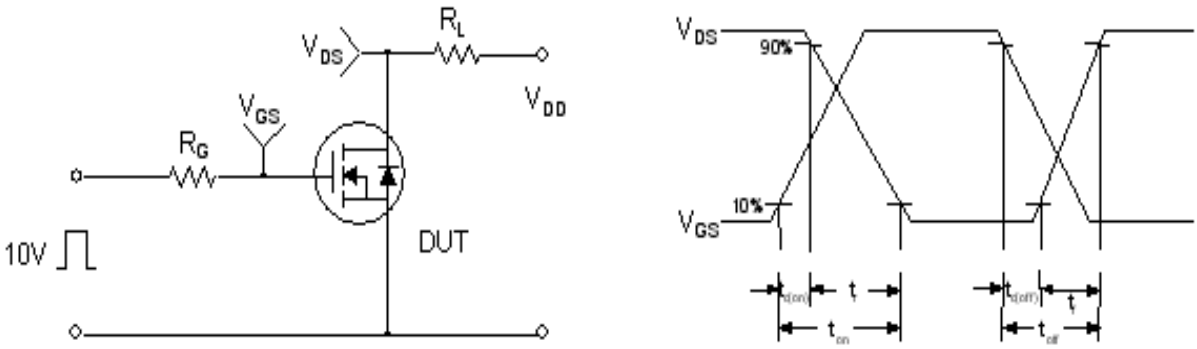

**Figure 10. Transient Thermal Response Curve**



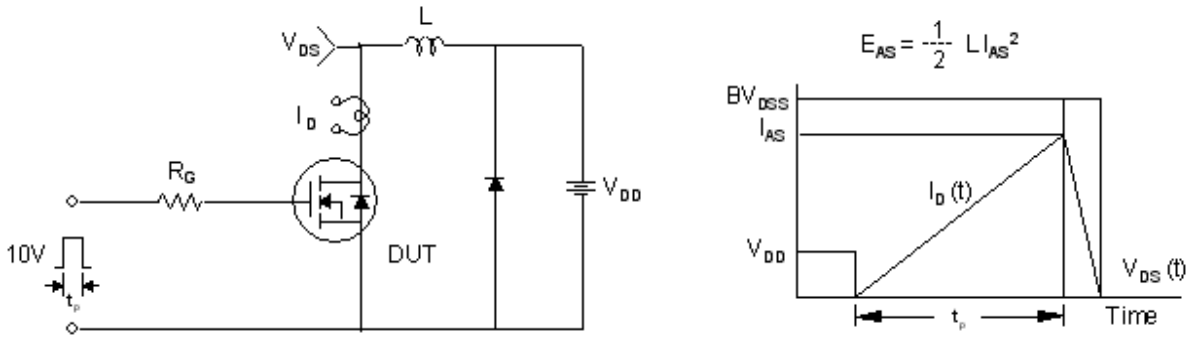
**Gate Charge Test Circuit & Waveform**



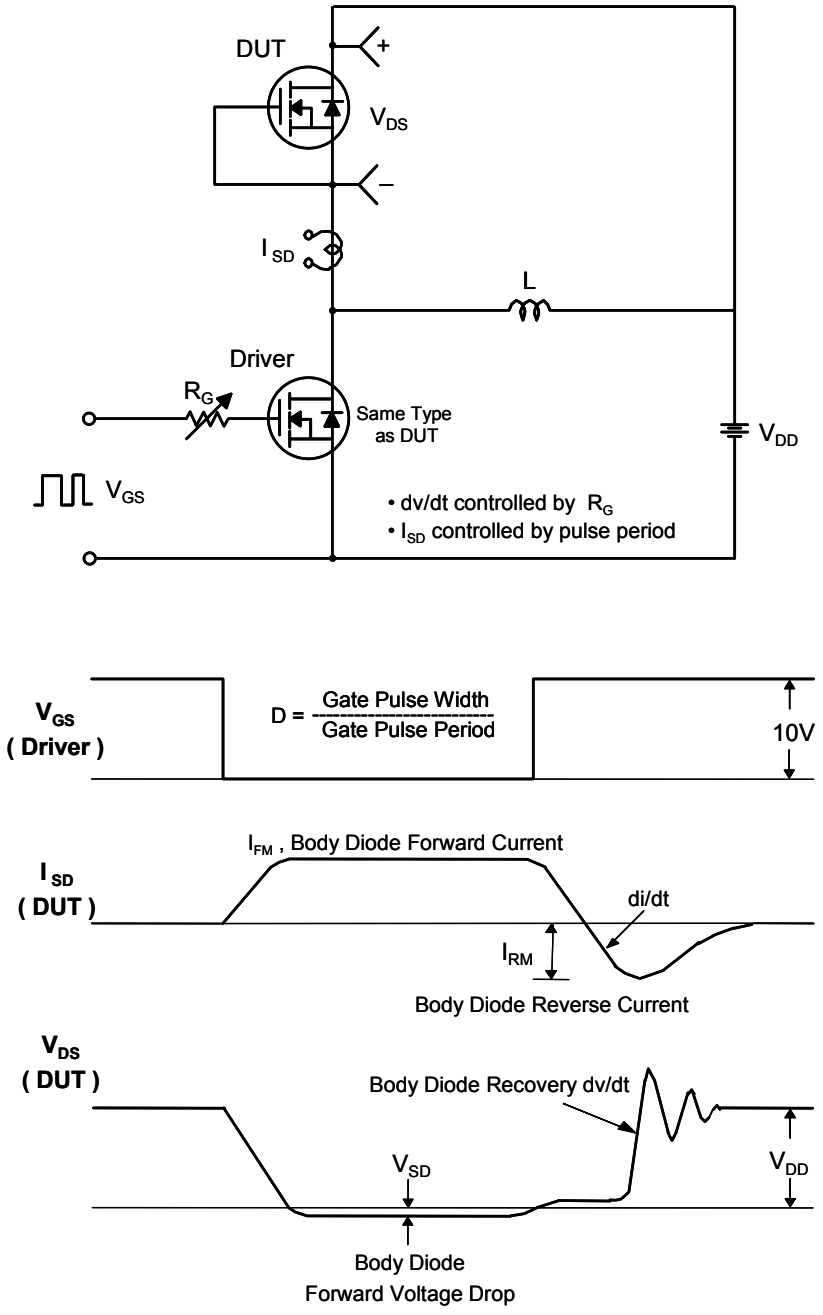

**Resistive Switching Test Circuit & Waveforms**




**Unclamped Inductive Switching Test Circuit & Waveforms**

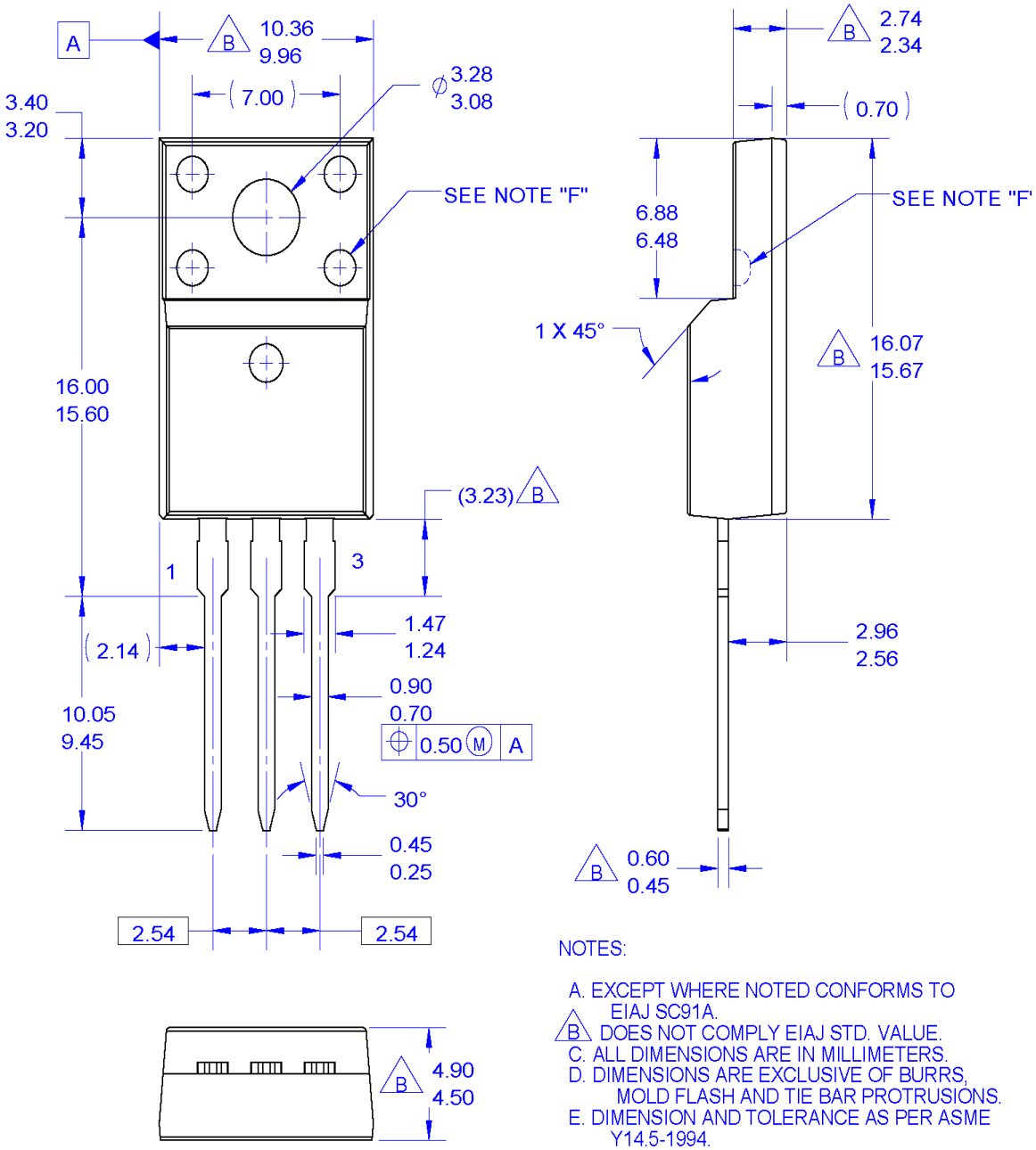


**Peak Diode Recovery dv/dt Test Circuit & Waveforms**



## Package Dimensions

# TO-220M03




NOTES:

A. EXCEPT WHERE NOTED CONFORMS TO EIAJ SC91A.
B. DOES NOT COMPLY EIAJ STD. VALUE.
C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
F. OPTION 1 - WITH SUPPORT PIN HOLE.
OPTION 2 - NO SUPPORT PIN HOLE.
G. DRAWING FILE NAME: TO220M03REV3

Dimensions in Millimeters

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